

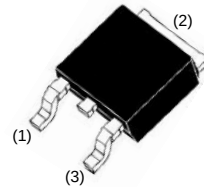
H15N65D

N-Channel Super Junction Power MOSFET

Features

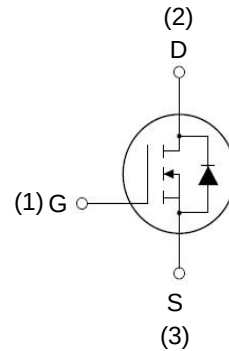
- New technology for high voltage device
- Low on-resistance and low conduction losses
- Small package
- Ultra Low Gate Charge cause lower driving requirements
- 100% Avalanche Tested
- ROHS compliant

TO-252



Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)



Schematic diagram

Absolute Maximum Ratings (T_c=25°C)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (V _{GS} =0V)	V _{DS}	650	V
Gate-Source Voltage (V _{DS} =0V) AC (f>1 Hz)	V _{GS}	±30	V
Continuous Drain Current at T _c =25°C	I _D (DC)	15	A
Continuous Drain Current at T _c =100°C	I _D (DC)	10	A
Pulsed drain current (Note 1)	I _{DM} (pulse)	60	A
Maximum Power Dissipation (T _c =25°C)	P _D	131	W
Derate above 25°C		1.05	W/°C
Single pulse avalanche energy (Note 2)	E _{AS}	304	mJ
Avalanche current (Note 1)	I _{AR}	3	A
Repetitive Avalanche energy, t _{AR} limited by T _{Jmax} (Note 1)	E _{AR}	1.6	mJ

Parameter	Symbol	Value	Unit
Drain Source voltage slope, $V_{DS} \leq 480V$,	dv/dt	50	V/ns
Reverse diode dv/dt , $V_{DS} \leq 480V, I_{SD} < I_D$	dv/dt	15	V/ns
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55...+150	°C

* limited by maximum junction temperature

Thermal Characteristic

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Maximum)	R_{thJC}	0.95	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	R_{thJA}	62	°C /W

Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
On/off states						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	650			V
Zero Gate Voltage Drain Current(Tc=25℃)	I _{DSS}	V _{DS} =650V, V _{GS} =0V			1	μA
Zero Gate Voltage Drain Current(Tc=125℃)	I _{DSS}	V _{DS} =650V, V _{GS} =0V			100	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	3	3.5	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =8A		220	260	mΩ
Dynamic Characteristics						
Input Capacitance	C _{iss}	V _{DS} =50V, V _{GS} =0V, F=1.0MHz		1210	1400	pF
Output Capacitance	C _{oss}			74		pF
Reverse Transfer Capacitance	C _{rss}			0.2		pF
Total Gate Charge	Q _g	V _{DS} =480V, I _D =15A, V _{GS} =10V		24.7	42	nC
Gate-Source Charge	Q _{gs}			8.2		nC
Gate-Drain Charge	Q _{gd}			8.5		nC
Switching times						
Turn-on Delay Time	t _{d(on)}	V _{DD} =380V, I _D =8A, R _G =2.3Ω, V _{GS} =10V		14		nS
Turn-on Rise Time	t _r			8		nS
Turn-Off Delay Time	t _{d(off)}			55		nS
Turn-Off Fall Time	t _f			7		nS
Source- Drain Diode Characteristics						
Source-drain current(Body Diode)	I _{SD}	T _C =25℃			15	A
Pulsed Source-drain current(Body Diode)	I _{SDM}				60	A
Forward On Voltage	V _{SD}	T _j =25℃, I _{SD} =15A, V _{GS} =0V		0.9	1.2	V
Reverse Recovery Time	t _{rr}	T _j =25℃, I _F =7.5A, di/dt=100A/μs		240		nS
Reverse Recovery Charge	Q _{rr}			2		uC
Peak Reverse Recovery Current	I _{rrm}			17		A

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2. $T_J=25^\circ C, V_{DD}=50V, V_G=10V, R_G=25\Omega$

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Figure1. Safe operating area

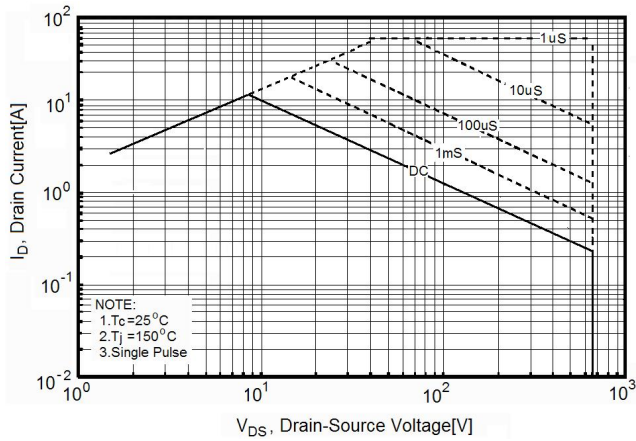


Figure2. Transient Thermal Impedance

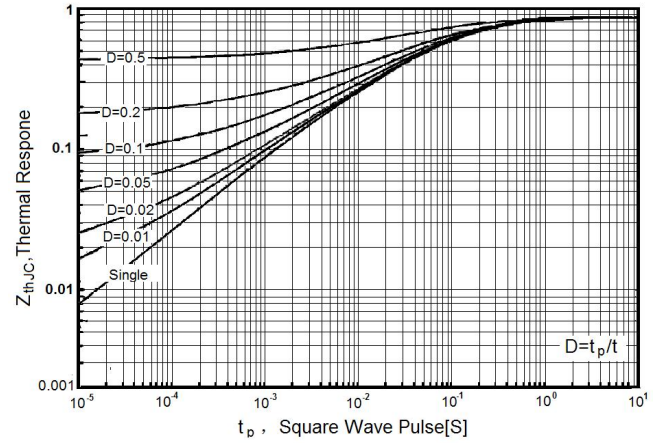


Figure3. Source-Drain Diode Forward Voltage

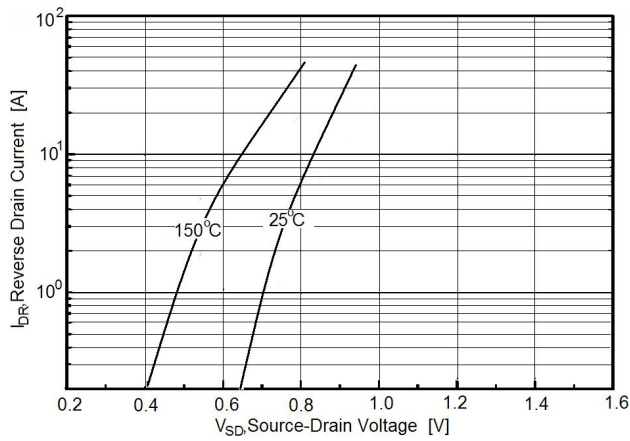


Figure4. Output characteristics

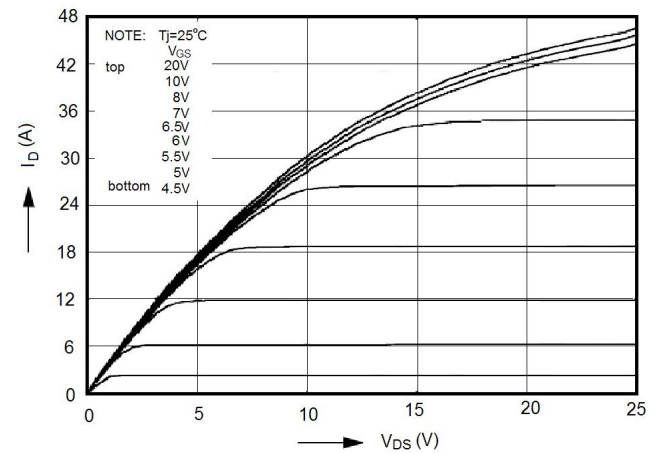


Figure5. Transfer characteristics

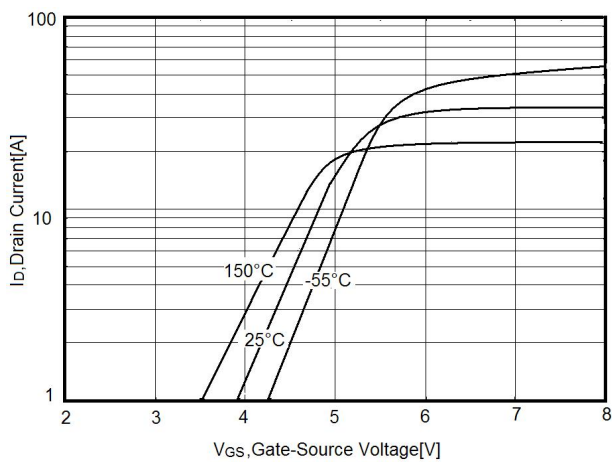


Figure6. Static drain-source on resistance

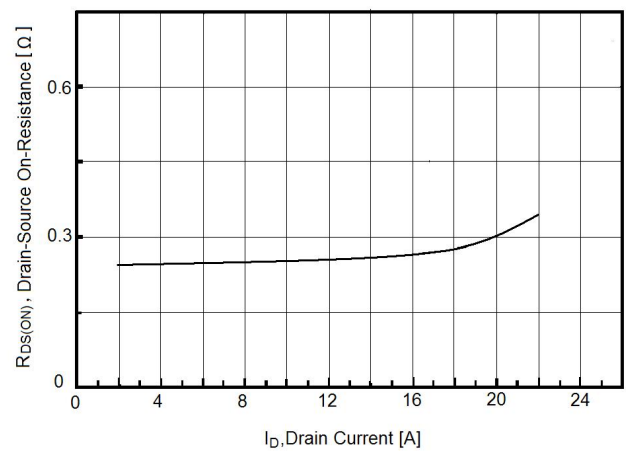
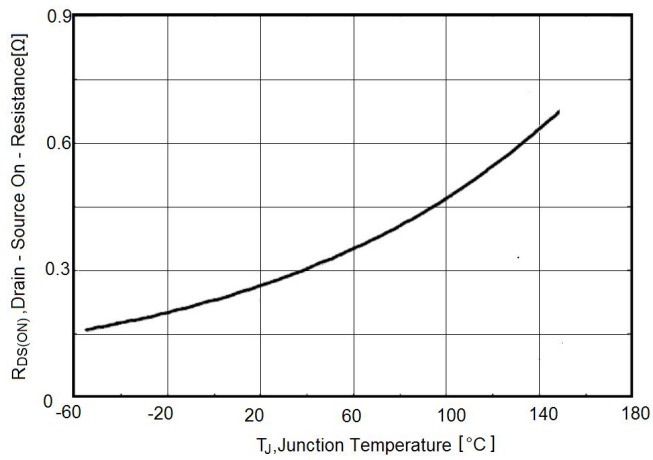
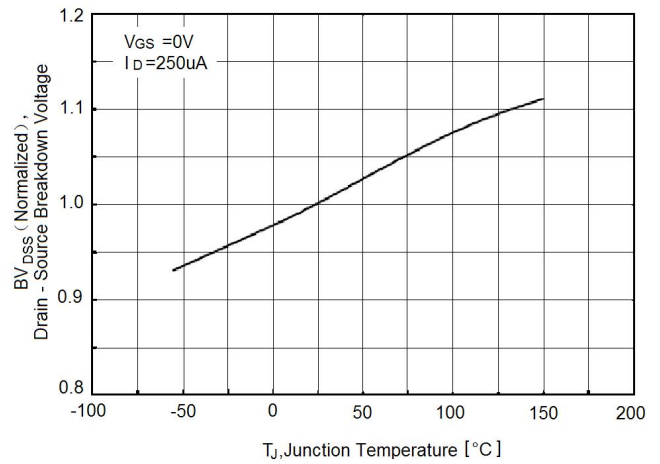
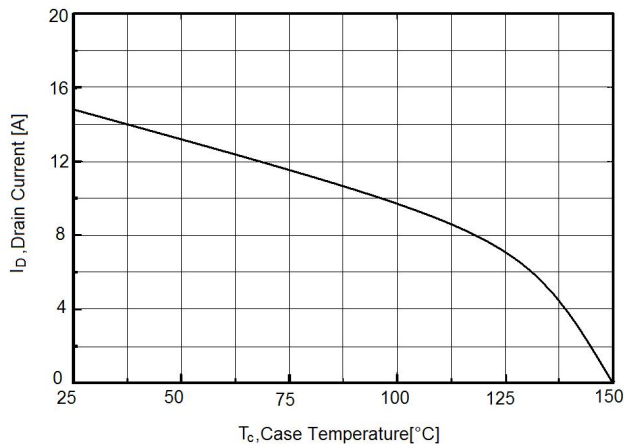
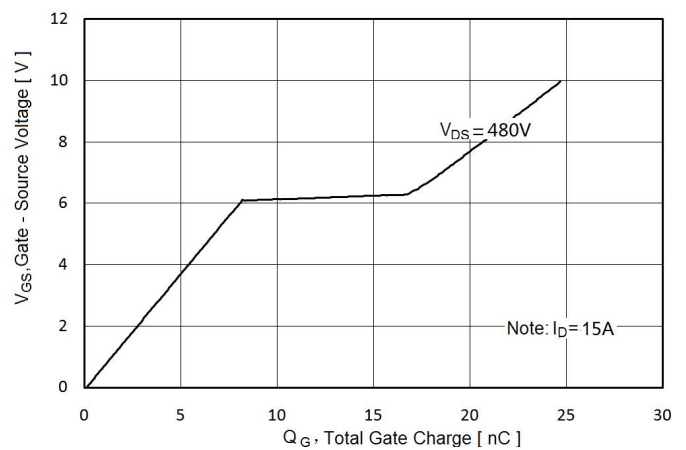
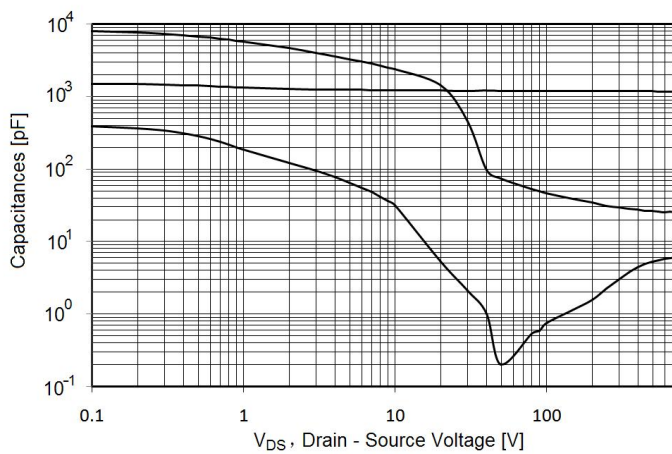
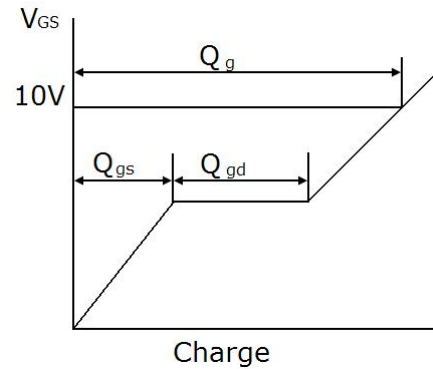
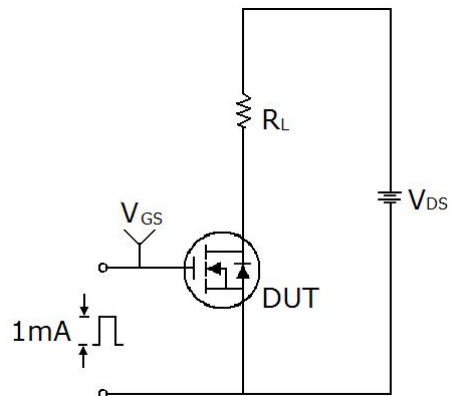


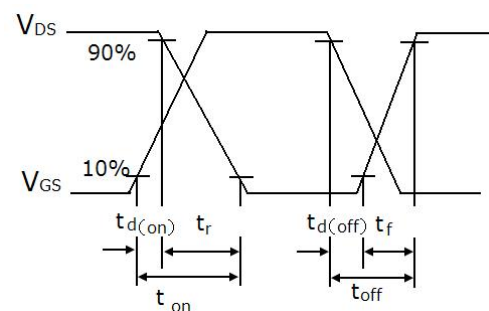
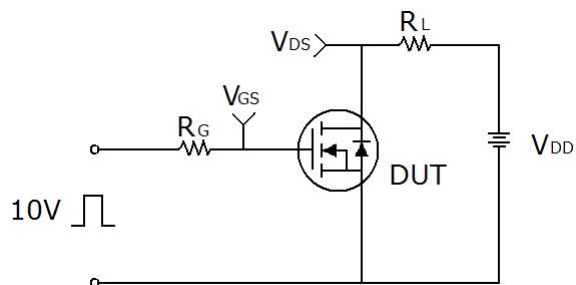
Figure7. $R_{DS(ON)}$ vs Junction Temperature

Figure8. BV_{DSS} vs Junction Temperature

Figure9. Maximum I_D vs Junction Temperature

Figure10. Gate charge waveforms

Figure11. Capacitance


Test circuit

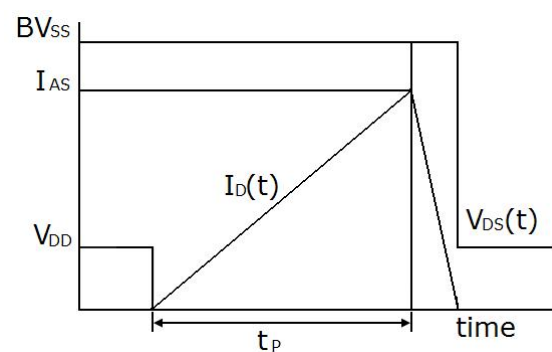
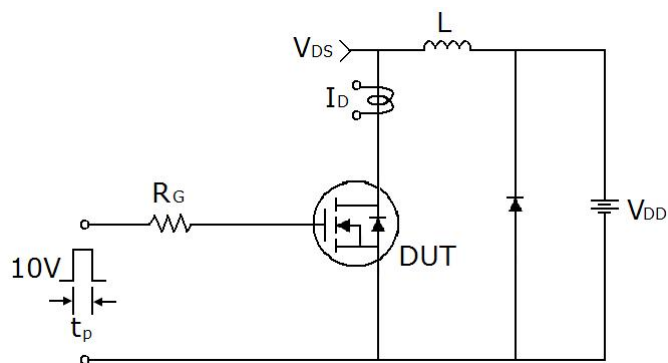
1) Gate charge test circuit & Waveform



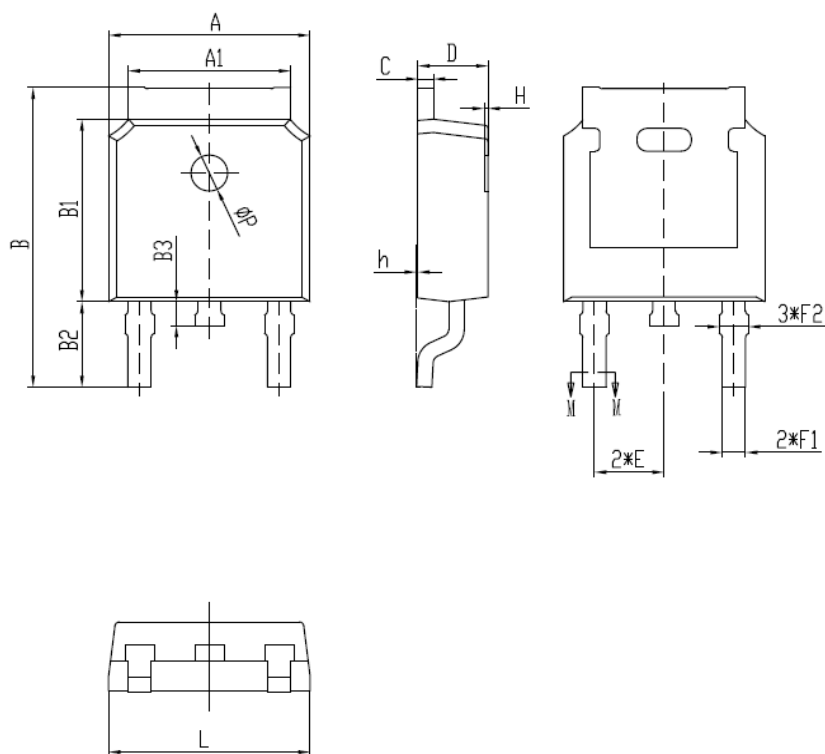
2) Switch Time Test Circuit:



3) Unclamped Inductive Switching Test Circuit & Waveforms



TO-252 Package Outline Dimensions



Symbol	Dimensions in Millimeters	
	MIN	MAX
A	6.50	6.70
A1	5.16	5.46
B	9.77	10.17
B1	6.00	6.20
B2	2.60	3.00
B3	0.70	0.90
C	0.45	0.61
D	2.20	2.40
E	2.186	2.386
F1	0.67	0.87
F2	0.76	0.96
H	0.00	0.30
h	0.00	0.127
L	6.50	6.70
Φ P	1.10	1.30